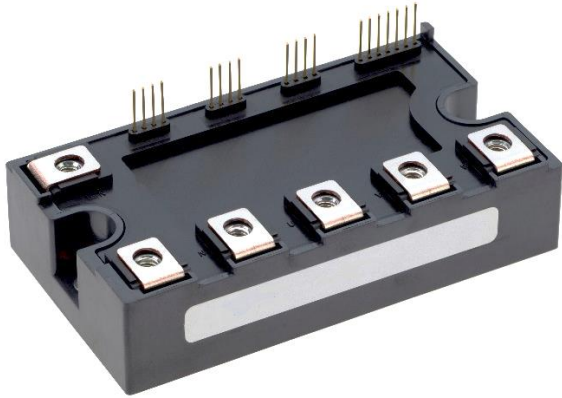


<Intelligent Power Modules>

# PM75RG1A065

FLAT-BASE TYPE  
INSULATED PACKAGE



## FEATURE

- a) Adopting Full-Gate CSTBT™ chip.
- b) The over-temperature protection which detects the chip surface temperature of CSTBT™ is adopted.
- c) Error output signal is available from each protection upper and lower arm of IPM.
- d) Outputting an error signal corresponding to the abnormal state (error mode identification)

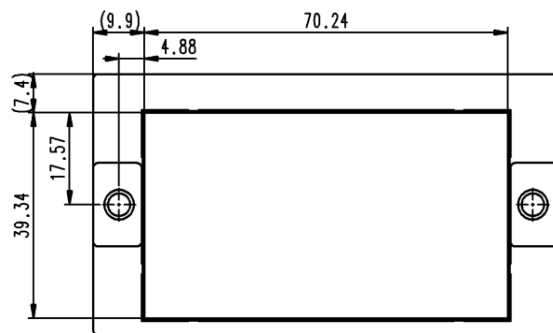
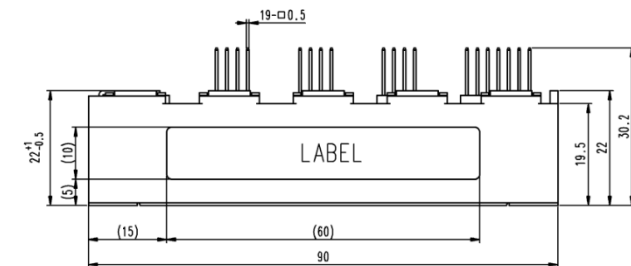
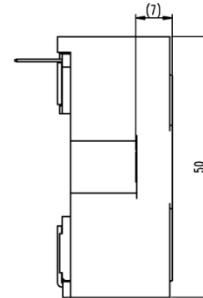
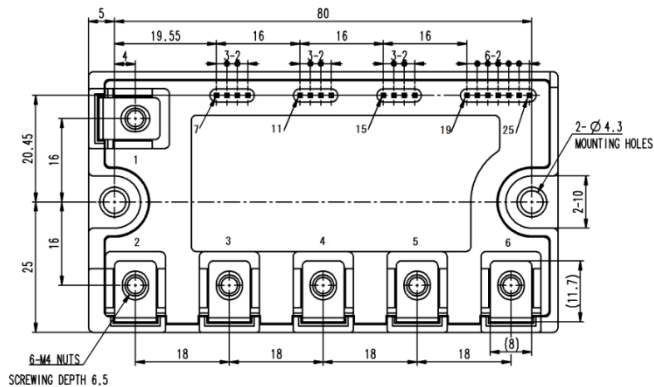
UL Recognized under UL1557, File No. E323585

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU and (EU)2015/863.

## APPLICATION

General purpose inverter, servo drives and other motor controls

## PACKAGE OUTLINES



## Dimensions in mm

Tolerance otherwise specified

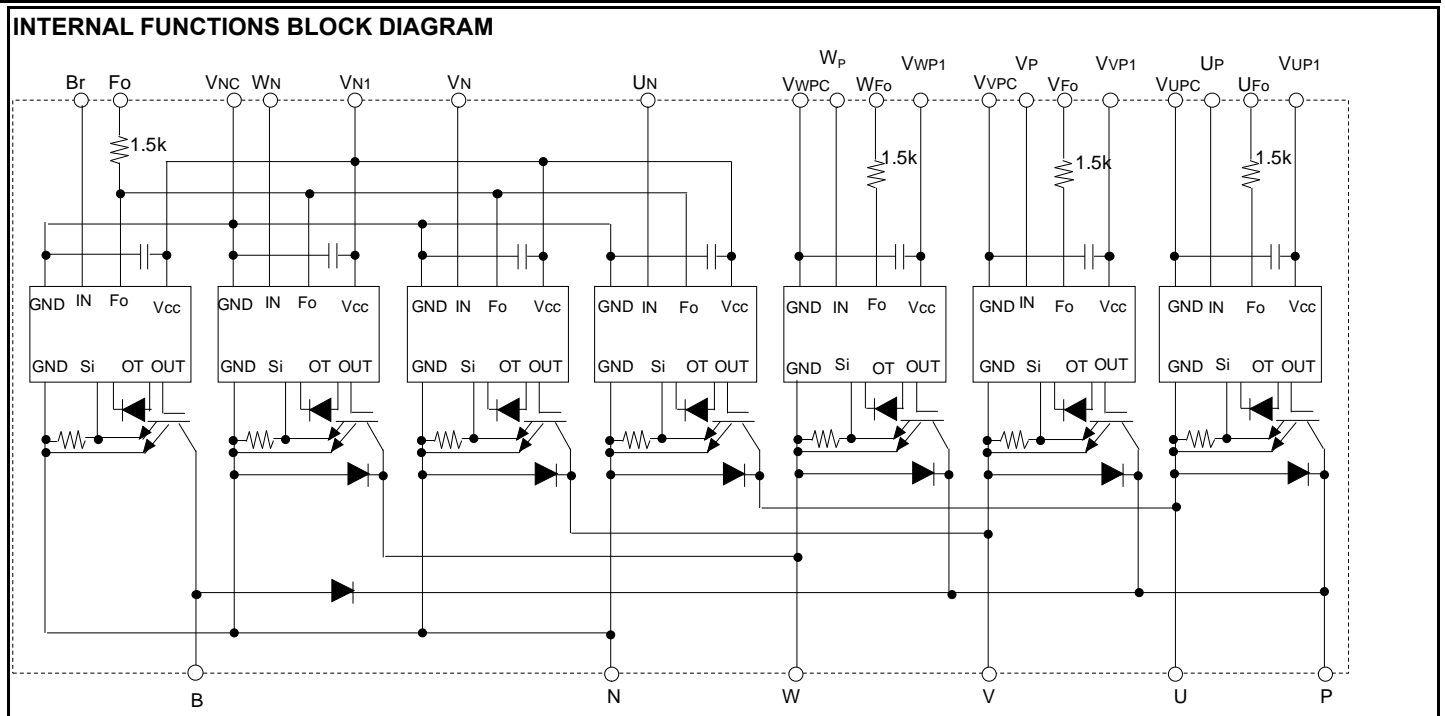
| Division of Dimension | Tolerance |
|-----------------------|-----------|
| 0.5 to 3              | ±0.2      |
| over 3 to 6           | ±0.3      |
| over 6 to 30          | ±0.5      |
| over 30 to 120        | ±0.8      |
| over 120 to 400       | ±1.2      |

## TERMINAL CODE

1.B, 2.P, 3.N, 4.U, 5.V, 6.W, 7.V<sub>UPC</sub>, 8.U<sub>FO</sub>, 9.U<sub>P</sub>, 10.V<sub>UP1</sub>, 11.V<sub>VPC</sub>, 12.V<sub>FO</sub>, 13.V<sub>P</sub>, 14.V<sub>VP1</sub>, 15.V<sub>WPC</sub>, 16.W<sub>FO</sub>, 17.W<sub>P</sub>, 18.V<sub>WP1</sub>, 19.V<sub>NC</sub>, 20.V<sub>N1</sub>, 21.BR, 22.UN, 23.V<sub>N</sub>, 24.W<sub>N</sub>, 25.F<sub>O</sub>

# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE



## MAXIMUM RATINGS (Tvj = 25°C, unless otherwise noted)

### INVERTER PART

| Symbol    | Parameter                             | Conditions                             | Ratings    | Unit |
|-----------|---------------------------------------|----------------------------------------|------------|------|
| $V_{CES}$ | Collector-Emitter Voltage             | $V_D=15\text{ V}, V_{CIN}=15\text{ V}$ | 650        | V    |
| $I_C$     | Collector Current                     | $T_C=25\text{ °C}$                     | 75         | A    |
| $I_{CRM}$ |                                       | Pulse                                  | 150        |      |
| $P_{tot}$ | Total Power Dissipation               | $T_C=25\text{ °C}$                     | 297        | W    |
| $I_E$     | Emitter Current                       | $T_C=25\text{ °C}$                     | 75         | A    |
| $I_{ERM}$ | (Free-wheeling Diode Forward current) | Pulse                                  | 150        |      |
| $Tvj$     | Junction Temperature                  | (Note5)                                | -20 ~ +150 | °C   |

\*: Tc measurement point is just under the chip.

### BRAKE PART

| Symbol      | Parameter                      | Conditions                             | Ratings    | Unit |
|-------------|--------------------------------|----------------------------------------|------------|------|
| $V_{CES}$   | Collector-Emitter Voltage      | $V_D=15\text{ V}, V_{CIN}=15\text{ V}$ | 650        | V    |
| $I_C$       | Collector Current              | $T_C=25\text{ °C}$                     | 50         | A    |
| $I_{CRM}$   |                                | Pulse                                  | 100        |      |
| $P_{tot}$   | Total Power Dissipation        | $T_C=25\text{ °C}$                     | 240        | W    |
| $V_{R(DC)}$ | Diode Rated Reverse DC Voltage | $T_C=25\text{ °C}$                     | 650        | V    |
| $I_F$       | Diode Forward Current          | $T_C=25\text{ °C}$                     | 50         | A    |
| $Tvj$       | Junction Temperature           | (Note5)                                | -20 ~ +150 | °C   |

\*: Tc measurement point is just under the chip.

### CONTROL PART

| Symbol    | Parameter                   | Conditions                                                                          | Ratings | Unit |
|-----------|-----------------------------|-------------------------------------------------------------------------------------|---------|------|
| $V_D$     | Supply Voltage              | Applied between: $V_{UP1}-V_{UPC}, V_{VP1}-V_{VPC}, V_{WP1}-V_{WPC}, V_{N1}-V_{NC}$ | 20      | V    |
| $V_{CIN}$ | Input Voltage               | Applied between: $U_P-V_{UPC}, V_P-V_{VPC}, W_P-V_{WPC}, U_N, V_N, W_N, Br -V_{NC}$ | 20      | V    |
| $V_{FO}$  | Fault Output Supply Voltage | Applied between: $U_{FO}-V_{UPC}, V_{FO}-V_{VPC}, W_{FO}-V_{WPC}, Fo-V_{NC}$        | 20      | V    |
| $I_{FO}$  | Fault Output Current        | Sink current at $U_{FO}, V_{FO}, W_{FO}, Fo$ terminals                              | 20      | mA   |

# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

## TOTAL SYSTEM

| Symbol         | Parameter                      | Conditions                                                                                      | Ratings    | Unit             |
|----------------|--------------------------------|-------------------------------------------------------------------------------------------------|------------|------------------|
| $V_{CC(Prot)}$ | Supply Voltage Protected by SC | $V_D = 13.5 \text{ V} \sim 16.5 \text{ V}$ , Inverter Part, $T_{vj} = +125^\circ\text{C}$ start | 400        | V                |
| $T_{stg}$      | Storage Temperature            | -                                                                                               | -40 ~ +125 | $^\circ\text{C}$ |
| $T_C$          | Operating Case Temperature     | (Note5)                                                                                         | -20 ~ +125 | $^\circ\text{C}$ |
| $V_{isol}$     | Isolation Voltage              | 60Hz, Sinusoidal, Charged part to Base plate, AC 1min, RMS                                      | 2500       | V                |

\*:  $T_c$  measurement point is just under the chip.

## THERMAL RESISTANCE

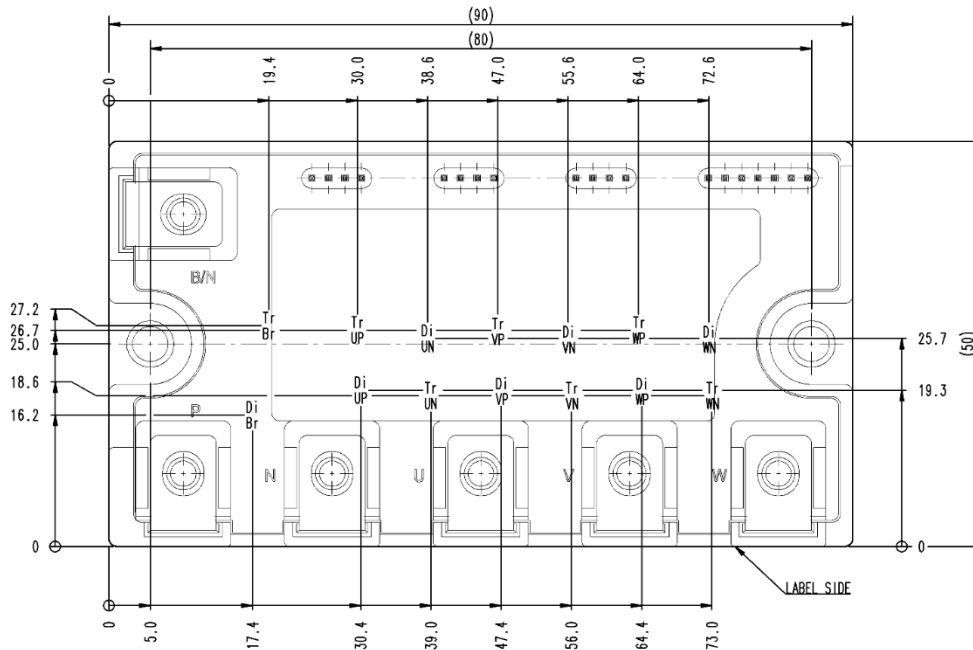
| Symbol         | Parameter                  | Conditions                                                                | Limits |      |      | Unit |
|----------------|----------------------------|---------------------------------------------------------------------------|--------|------|------|------|
|                |                            |                                                                           | Min.   | Typ. | Max. |      |
| $R_{th(j-c)Q}$ | Thermal Resistance         | Inverter, Junction to case, IGBT, per 1 element (Note1)                   | -      | -    | 0.42 | K/W  |
| $R_{th(j-c)D}$ |                            | Inverter, Junction to case, FWD, per 1 element (Note1)                    | -      | -    | 0.68 |      |
| $R_{th(j-c)Q}$ |                            | Brake, Junction to case, IGBT, per 1 element (Note1)                      | -      | -    | 0.52 |      |
| $R_{th(j-c)D}$ |                            | Brake, Junction to case, FWD, per 1 element (Note1)                       | -      | -    | 0.88 |      |
| $R_{th(c-s)}$  | Contact Thermal Resistance | Case to heat sink, per 1 module,<br>Thermal grease applied (Note.1, 2, 5) | -      | 19.1 | -    | K/kW |

Note1. If you use this value,  $R_{th(s-a)}$  should be measured just under the chips.

Note2. Typical value is by thermally conductive grease of  $\lambda = 0.9 \text{ W}/(\text{m}\cdot\text{K})$ ,  $D_{(c-s)} = 50 \mu\text{m}$ .

### CHIP LOCATION (Top view)

Dimension in mm, tolerance:  $\pm 1 \text{ mm}$



Tr\*\* : IGBT  
Di\*\* : FWD

# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

## ELECTRICAL CHARACTERISTICS (Tvj= 25°C, unless otherwise noted)

### INVERTER PART

| Symbol              | Parameter                            | Conditions                                                                                                                                       |            |            | Limits |      |      | Unit |
|---------------------|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|------------|------------|--------|------|------|------|
|                     |                                      |                                                                                                                                                  |            |            | Min.   | Typ. | Max. |      |
| V <sub>CEsat</sub>  | Collector-Emitter Saturation Voltage | V <sub>D</sub> =15 V, I <sub>C</sub> =75 A                                                                                                       | Tvj=25 °C  | Terminal   | -      | -    | 1.75 | V    |
|                     |                                      |                                                                                                                                                  |            | Chip       | -      | 1.25 | -    |      |
|                     |                                      | V <sub>CIN</sub> =0 V, Pulsed, (Fig.1)                                                                                                           | Tvj=125 °C | Terminal   | -      | -    | 2.0  |      |
|                     |                                      |                                                                                                                                                  |            | Chip       | -      | 1.33 | -    |      |
| V <sub>EC</sub>     | Emitter-Collector Voltage            | V <sub>D</sub> =15 V, I <sub>E</sub> =75 A,                                                                                                      | Tvj=25 °C  | Terminal   | -      | -    | 1.95 | V    |
|                     |                                      |                                                                                                                                                  |            | Chip       | -      | 1.40 | -    |      |
|                     |                                      | V <sub>CIN</sub> = 15 V, pulsed, (Fig.2)                                                                                                         | Tvj=125 °C | Terminal   | -      | -    | 2.05 |      |
|                     |                                      |                                                                                                                                                  |            | Chip       | -      | 1.45 | -    |      |
| t <sub>on</sub>     | Switching Time                       | V <sub>D</sub> =15 V, V <sub>CIN</sub> =0 V↔15 V,<br>V <sub>CC</sub> =300 V, I <sub>C</sub> =75A,<br>Tvj=125 °C,<br>Inductive Load<br>(Fig.3, 4) |            |            | 0.3    | 0.6  | 1.2  | μs   |
| t <sub>rr</sub>     |                                      |                                                                                                                                                  |            |            | -      | 0.2  | 0.65 |      |
| t <sub>c(on)</sub>  |                                      |                                                                                                                                                  |            |            | -      | 0.17 | 0.75 |      |
| t <sub>off</sub>    |                                      |                                                                                                                                                  |            |            | -      | 1.0  | 2.3  |      |
| t <sub>c(off)</sub> |                                      |                                                                                                                                                  |            |            | -      | 0.13 | 0.4  |      |
| I <sub>CES</sub>    | Collector-Emitter Cut-off Current    | V <sub>CE</sub> =V <sub>CES</sub> , V <sub>D</sub> =15 V,<br>V <sub>CIN</sub> =15 V (Fig.5)                                                      |            | Tvj=25 °C  | -      | -    | 1    | mA   |
|                     |                                      |                                                                                                                                                  |            | Tvj=125 °C | -      | -    | 10   |      |

### BRAKE PART

| Symbol             | Parameter                            | Conditions                                                                               |            |            | Limits |      |      | Unit |
|--------------------|--------------------------------------|------------------------------------------------------------------------------------------|------------|------------|--------|------|------|------|
|                    |                                      |                                                                                          |            |            | Min.   | Typ. | Max. |      |
| V <sub>CEsat</sub> | Collector-Emitter Saturation Voltage | V <sub>D</sub> =15 V, I <sub>C</sub> =50 A                                               | Tvj=25 °C  | Terminal   | -      | -    | 1.7  | V    |
|                    |                                      |                                                                                          |            | Chip       | -      | 1.25 | -    |      |
|                    |                                      | V <sub>CIN</sub> =0 V, Pulsed, (Fig.1)                                                   | Tvj=125 °C | Terminal   | -      | -    | 1.95 |      |
|                    |                                      |                                                                                          |            | Chip       | -      | 1.33 | -    |      |
| V <sub>FM</sub>    | Diode Forward Voltage                | I <sub>F</sub> =50A                                                                      | Tvj=25 °C  | Terminal   | -      | -    | 1.9  | V    |
|                    |                                      |                                                                                          |            | Chip       | -      | 1.40 | -    |      |
|                    |                                      |                                                                                          | Tvj=125 °C | Terminal   | -      | -    | 2.0  |      |
|                    |                                      |                                                                                          |            | Chip       | -      | 1.45 | -    |      |
| I <sub>CES</sub>   | Collector-Emitter Cut-off Current    | V <sub>CE</sub> =V <sub>CES</sub> , V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V (Fig.5) |            | Tvj=25 °C  | -      | -    | 1    | mA   |
|                    |                                      |                                                                                          |            | Tvj=125 °C | -      | -    | 10   |      |

# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

## ELECTRICAL CHARACTERISTICS (Tvj = 25°C, unless otherwise noted)

### CONTROL PART

| Symbol               | Parameter                        | Conditions                                                                                                                                                                     | Limits                           |      |      | Unit |    |
|----------------------|----------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|------|------|------|----|
|                      |                                  |                                                                                                                                                                                | Min.                             | Typ. | Max. |      |    |
| I <sub>D</sub>       | Circuit Current                  | V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V                                                                                                                                   | V <sub>P1</sub> -V <sub>PC</sub> | -    | 4    | 6    | mA |
|                      |                                  |                                                                                                                                                                                | V <sub>N1</sub> -V <sub>NC</sub> | -    | 16   | 24   |    |
|                      |                                  | V <sub>D</sub> =15 V, V <sub>CIN</sub> =0 V ↔ 15 V, V <sub>CC</sub> =400 V<br>I <sub>C</sub> =0A, Tvj=125 °C, f <sub>C</sub> ≤20kHz                                            | V <sub>P1</sub> -V <sub>PC</sub> | -    | 12   | 15   |    |
|                      |                                  |                                                                                                                                                                                | V <sub>N1</sub> -V <sub>NC</sub> | -    | 46   | 54   |    |
| V <sub>th(ON)</sub>  | Input ON Threshold Voltage       | Applied between:                                                                                                                                                               | 1.2                              | 1.5  | 1.8  | V    |    |
| V <sub>th(OFF)</sub> | Input OFF Threshold Voltage      | U <sub>P</sub> -V <sub>UPC</sub> , V <sub>P</sub> -V <sub>VPC</sub> , W <sub>P</sub> -V <sub>WPC</sub> , U <sub>N</sub> , V <sub>N</sub> , W <sub>N</sub> , Br-V <sub>NC</sub> | 1.7                              | 2.0  | 2.3  |      |    |
| SC                   | Short Circuit Trip Level         | -20≤Tvj≤125 °C, V <sub>D</sub> =15 V (Fig.3, 6)                                                                                                                                | Inverter                         | 150  | -    | -    | A  |
|                      |                                  |                                                                                                                                                                                | Brake                            | 100  | -    | -    |    |
| t <sub>d(SC)</sub>   | Short Circuit Current Delay Time | V <sub>D</sub> =15 V, Tvj=125 °C (Fig.3, 6)                                                                                                                                    | -                                | 2.0  | -    | μs   |    |
| OT                   | Over Temperature Protection      | Detect temperature of IGBT chip surface                                                                                                                                        | Trip level                       | 150  | -    | -    | °C |
|                      |                                  |                                                                                                                                                                                | Hysteresis                       | -    | 20   | -    |    |
| UV <sub>t</sub>      | Supply Circuit                   | -                                                                                                                                                                              | Trip level                       | 11.0 | 12.0 | 12.7 | V  |
| UV <sub>r</sub>      | Under-Voltage Protection         |                                                                                                                                                                                | Reset level                      | -    | 12.5 | -    |    |
| I <sub>FO(H)</sub>   | Fault Output Current             | V <sub>D</sub> =15 V, V <sub>FO</sub> =15 V (Note3)                                                                                                                            | -                                | -    | 0.01 | mA   |    |
| I <sub>FO(L)</sub>   |                                  |                                                                                                                                                                                | -                                | 10   | 15   |      |    |
| t <sub>FO</sub>      | Fault Output Pulse Width         | V <sub>D</sub> =15 V (Note3)                                                                                                                                                   | OT                               | -    | 8.0  | -    | ms |
|                      |                                  |                                                                                                                                                                                | UV                               | -    | 4.0  | -    |    |
|                      |                                  |                                                                                                                                                                                | SC                               | -    | 2.0  | -    |    |

Note3. Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

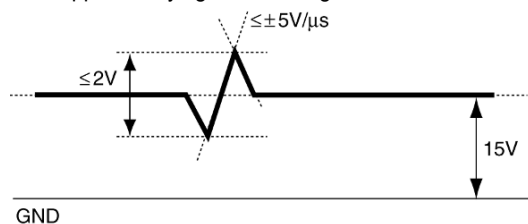
### MECHANICAL RATINGS AND CHARACTERISTICS

| Symbol         | Parameter       | Conditions                    | Limits |      |      | Unit |
|----------------|-----------------|-------------------------------|--------|------|------|------|
|                |                 |                               | Min.   | Typ. | Max. |      |
| M <sub>s</sub> | Mounting Torque | Mounting part screw : M4      | 1.5    | 1.7  | 2.0  | N•m  |
| M <sub>t</sub> | Mounting Torque | Main terminal part screw : M4 | 1.5    | 1.7  | 2.0  |      |
| m              | mass            | -                             | -      | 175  | -    | g    |

### RECOMMENDED CONDITIONS FOR USE

| Symbol                | Parameter                       | Conditions                                                                                                                                                                                          | Recommended value | Unit |
|-----------------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------|------|
| V <sub>CC</sub>       | Supply Voltage                  | Applied across P-N terminals                                                                                                                                                                        | ≤ 400             | V    |
| V <sub>D</sub>        | Control Supply Voltage          | Applied between :<br>V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> , V <sub>WP1</sub> -V <sub>WPC</sub> , V <sub>N1</sub> -V <sub>NC</sub> (Note4)                        | 15.0±1.5          | V    |
| V <sub>CIN(ON)</sub>  | Input ON Voltage                | Applied between :<br>U <sub>P</sub> -V <sub>UPC</sub> , V <sub>P</sub> -V <sub>VPC</sub> , W <sub>P</sub> -V <sub>WPC</sub> , U <sub>N</sub> , V <sub>N</sub> , W <sub>N</sub> , Br-V <sub>NC</sub> | ≤ 0.8             | V    |
| V <sub>CIN(OFF)</sub> | Input OFF Voltage               |                                                                                                                                                                                                     | ≥ 9.0             |      |
| f <sub>PWM</sub>      | PWM Input Frequency             | Using Application Circuit of Fig. 8                                                                                                                                                                 | ≤ 20              | kHz  |
| t <sub>dead</sub>     | Arm Shoot-through Blocking Time | For IPM's each input signals (Fig.7)                                                                                                                                                                | ≥ 2.0             | μs   |

Note4. With ripple satisfying the following conditions: dv/dt swing ≤ ±5 V/μs, Variation ≤ 2 V peak to peak



Note5. Long term performance related to thermal conductive material such as thermal grease (including but not limited to aspects such as the increase of thermal resistance due to pumping out, etc.) should be verified under your specific application conditions. Each temperature condition (Tvj, Tc) must be maintained below the maximum rated temperature throughout consideration of the temperature rise even for long term usage.

# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

## PRECAUTIONS FOR TESTING

1. Before applying any control supply voltage ( $V_D$ ), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state.

After this, the specified ON and OFF level setting for each input signal should be done.

2. When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above  $V_{CES}$  rating of the device.

(These test should not be done by using a curve tracer or its equivalent.)



Fig.1  $V_{CEsat}$  Test

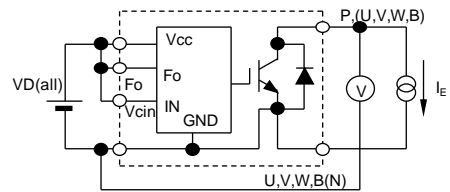


Fig.2  $V_{EC}$  Test

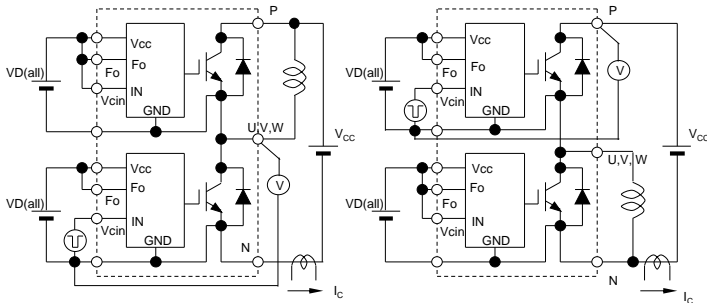


Fig.3 Switching time and SC test circuit

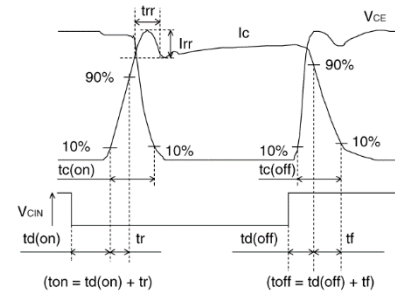


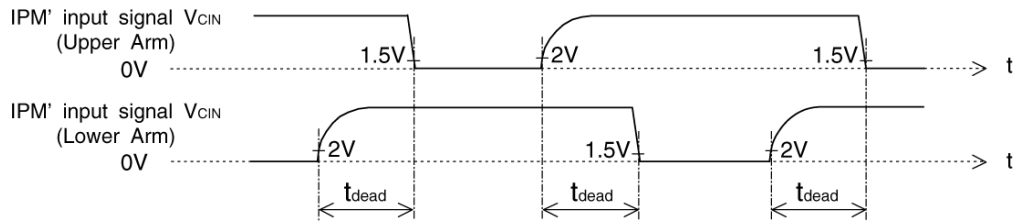
Fig.4 Switching time test waveform



Fig.5  $I_{CES}$  Test



Fig.6 SC test waveform



1.5V: Input on threshold voltage  $V_{th(on)}$  typical value, 2V: Input off threshold voltage  $V_{th(off)}$  typical value

Fig. 7 Dead time measurement point example

# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

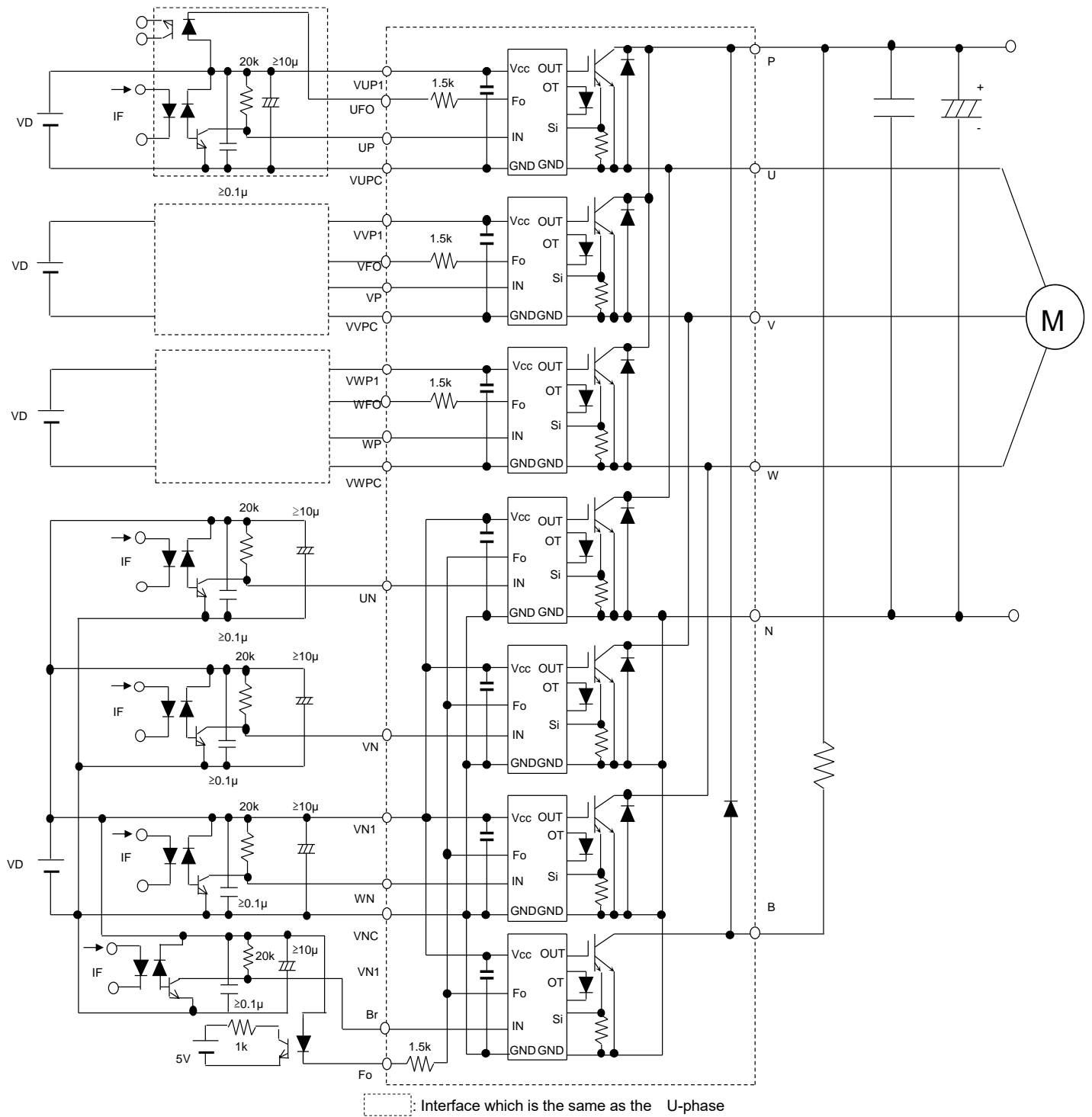


Fig. 8 Application Example Circuit

### NOTES FOR STABLE AND SAFE OPERATION ;

- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers:  $t_{PLH}$ ,  $t_{PHL} \leq 0.8\mu s$ , Use High CMR type.
- Slow switching opto-coupler:  $CTR > 100\%$  (\*can be applied to Brake part input signal, in this case, resistor should be selected properly).
- Use 4 isolated control power supplies (VD). Also, care should be taken to minimize the instantaneous voltage charge of the power supply.
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.

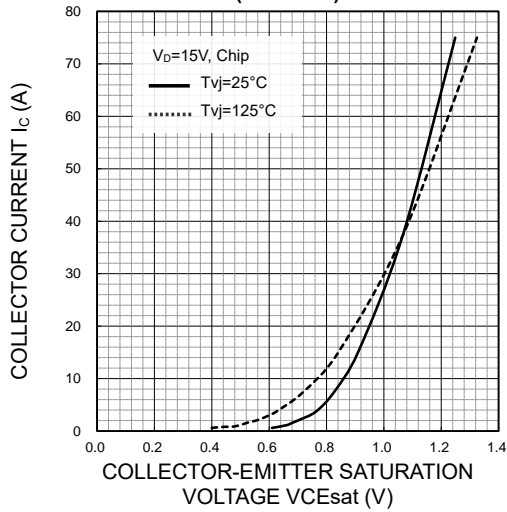
# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

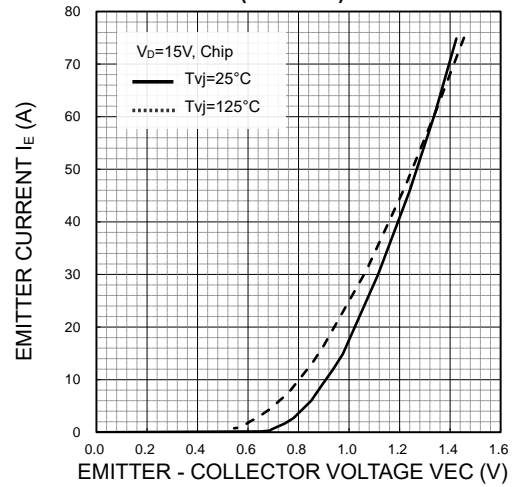
## PERFORMANCE CURVES

Inverter part

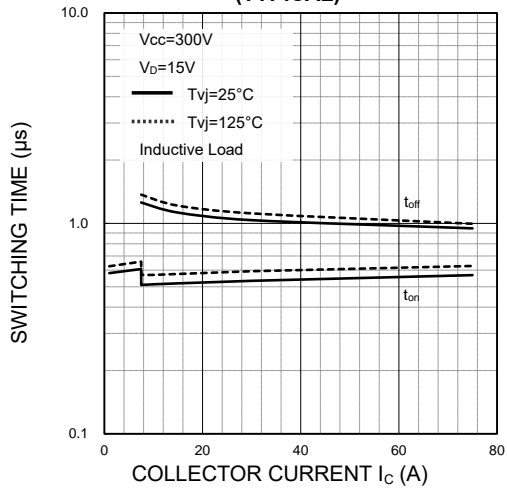
**COLLECTOR-EMITTER SATURATION VOLTAGE (VS.  $I_c$ ) CHARACTERISTICS (TYPICAL)**



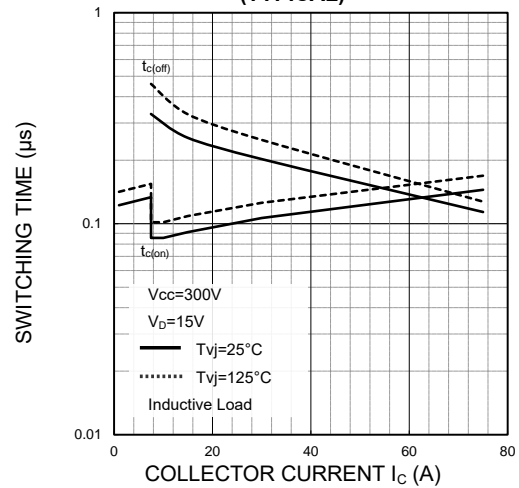
**FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)**



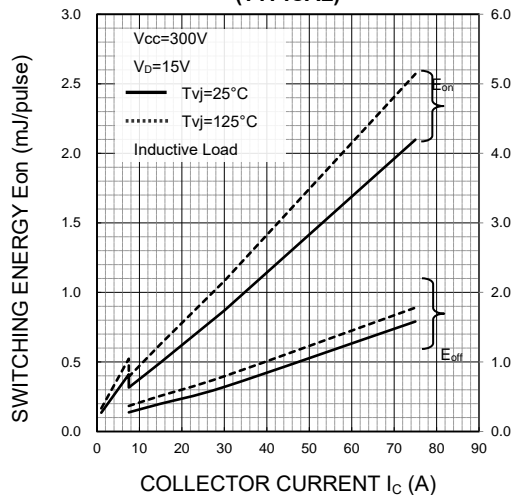
**SWITCHING TIME ( $t_{on}$ ,  $t_{off}$ ) CHARACTERISTICS (TYPICAL)**



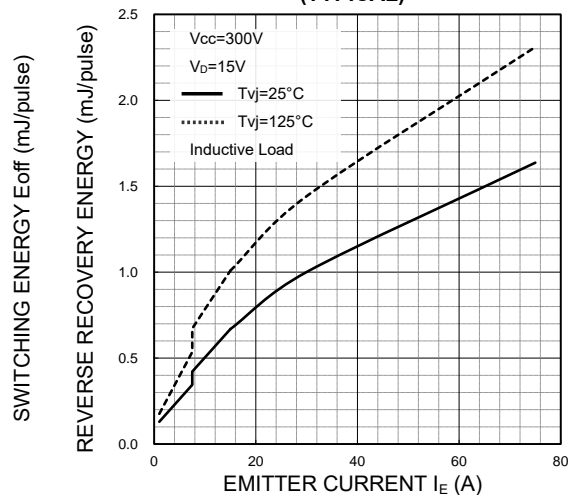
**SWITCHING TIME ( $t_{c(on)}$ ,  $t_{c(off)}$ ) CHARACTERISTICS (TYPICAL)**



**SWITCHING ENERGY CHARACTERISTICS (TYPICAL)**



**FREE WHEELING DIODE REVERSE RECOVERY ENERGY CHARACTERISTICS (TYPICAL)**

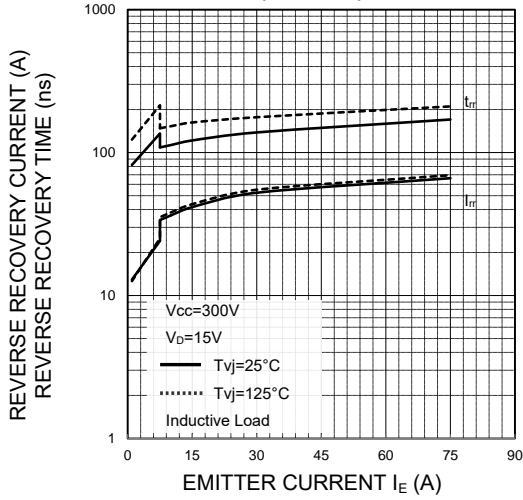




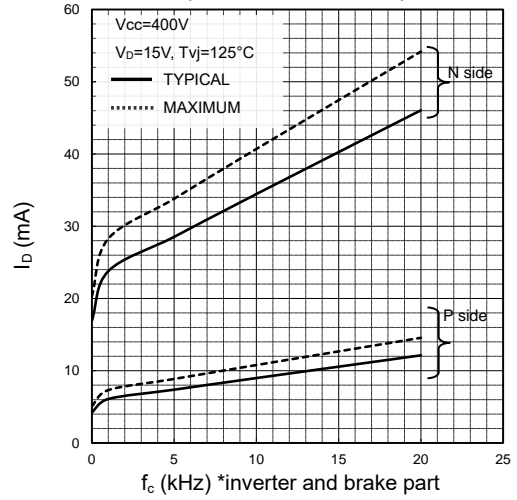
# PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

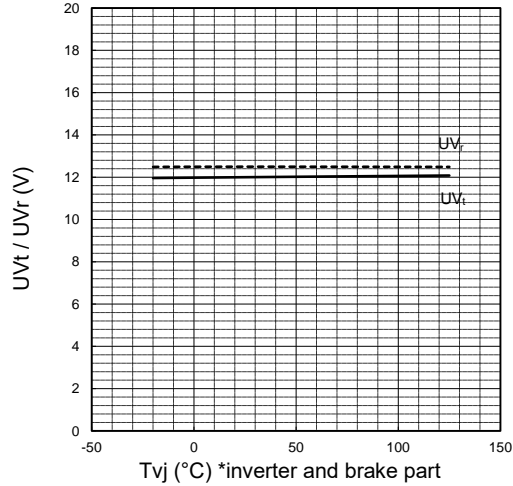
**FREE WHEELING DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)**



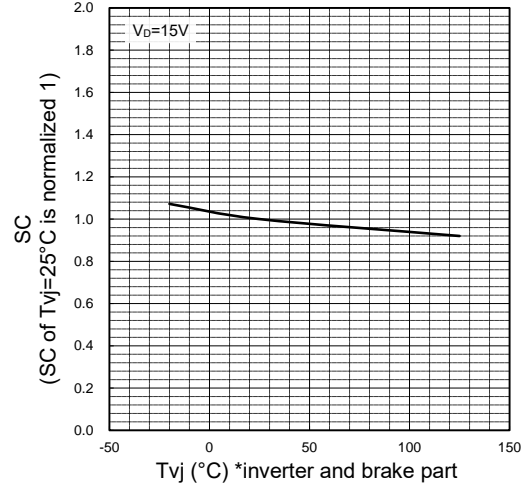
**$I_D$  VS.  $f_c$  CHARACTERISTICS (TYPICAL, MAXIMUM)**



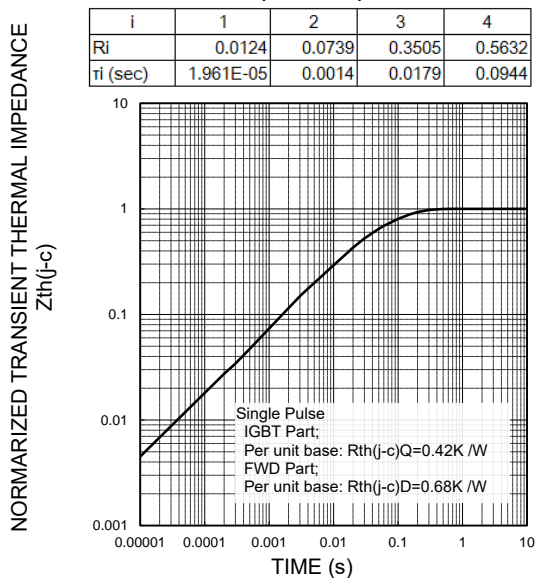
**UV TRIP LEVEL VS.  $T_{vj}$  CHARACTERISTICS (TYPICAL)**



**SC TRIP LEVEL VS.  $T_{vj}$  CHARACTERISTICS (TYPICAL)**



**TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (TYPICAL)**



# PM75RG1A065

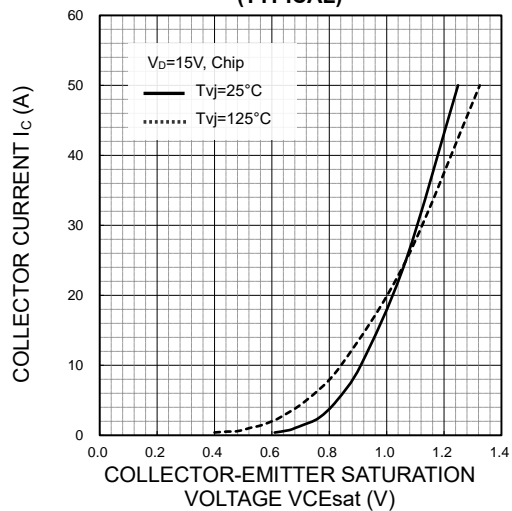
HIGH POWER SWITCHING USE

INSULATED TYPE

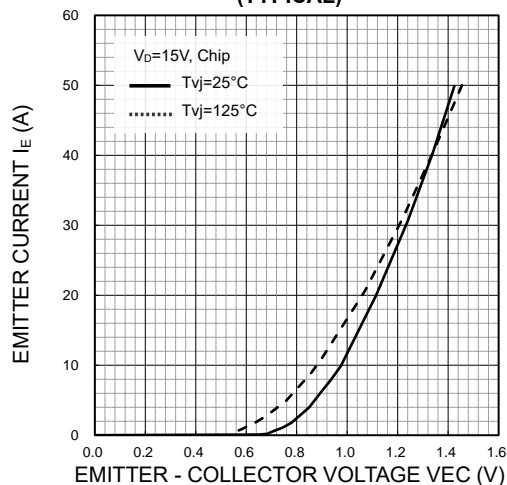
## PERFORMANCE CURVES

Brake part

**COLLECTOR-EMITTER SATURATION VOLTAGE (VS.  $I_c$ ) CHARACTERISTICS (TYPICAL)**

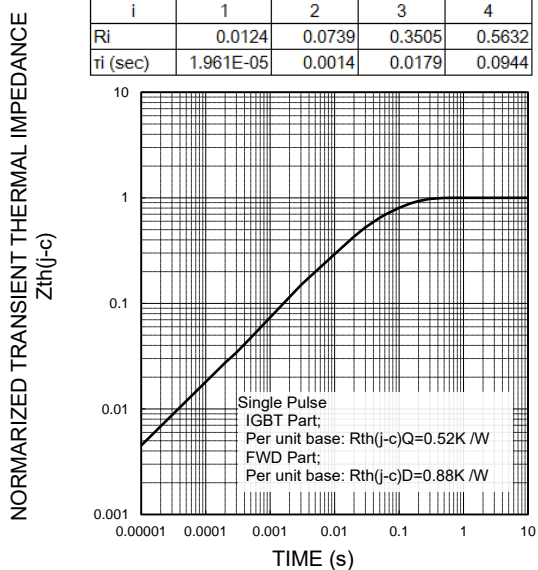


**FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)**



**TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (TYPICAL)**

| i           | 1         | 2      | 3      | 4      |
|-------------|-----------|--------|--------|--------|
| $R_i$       | 0.0124    | 0.0739 | 0.3505 | 0.5632 |
| $t_i$ (sec) | 1.961E-05 | 0.0014 | 0.0179 | 0.0944 |



**Note:**

The characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## PM75RG1A065

HIGH POWER SWITCHING USE  
INSULATED TYPE

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